

Description

The VSM3406N uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

• $V_{DS} = 30V, I_{D} = 6A$

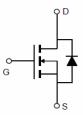
 $R_{DS(ON)} < 50 \text{m}\Omega$ @ V_{GS} =2.5V

 $R_{DS(ON)}$ < 32m Ω @ V_{GS} =4.5V

 $R_{DS(ON)}$ < 28m Ω @ V_{GS} =10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- PWM applications
- Load switch
- Power management





SOT-23-6

Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM3406N-S6	VSM3406N	SOT-23-6	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

		1.1.14	
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	Vgs	±12	V
Drain Current-Continuous	I _D	6	А
Drain Current-Pulsed (Note 1)	I _{DM}	30	А
Maximum Power Dissipation	P _D	2.0	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

THOMAS TOOLS AND SOME STATE OF THE SOURCE STAT	Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	62.5	°C/W
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Electrical Characteristics (T_A=25°Cunless otherwise noted)

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Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	33	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA	



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Parameter	Symbol	Condition	Min	Тур	Max	Unit	
On Characteristics (Note 3)							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.7	0.9	1.4	V	
		V _{GS} =2.5V, I _D =4A	-	27	50	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =5A	-	24	32	mΩ	
		V _{GS} =10V, I _D =6A	-	20.5	28	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A	10	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}	\/ -15\/\/ -0\/	-	820	-	PF	
Output Capacitance	Coss	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	99	-	PF	
Reverse Transfer Capacitance	C _{rss}	F-1.UIVITZ	-	77	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	3.3	-	nS	
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =2.5 Ω V_{GS} =10V, R_{GEN} =3 Ω	-	4.8	-	nS	
Turn-Off Delay Time	t _{d(off)}		-	26	-	nS	
Turn-Off Fall Time	t _f		-	4	-	nS	
Total Gate Charge	Qg	V _{DS} =15V,I _D =6A, V _{GS} =4.5V	-	9.5	-	nC	
Gate-Source Charge	Q _{gs}		-	1.5	-	nC	
Gate-Drain Charge	Q_{gd}	v _{GS} -4.5v	-	3	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	6	Α	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

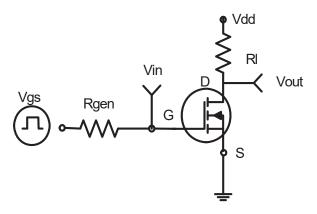


Figure 1:Switching Test Circuit

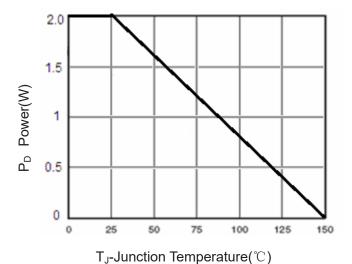


Figure 3 Power Dissipation

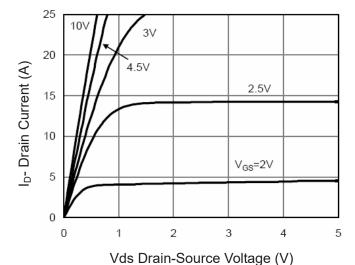


Figure 5 Output Characteristics

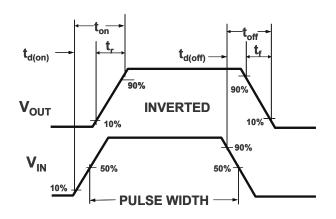


Figure 2:Switching Waveforms

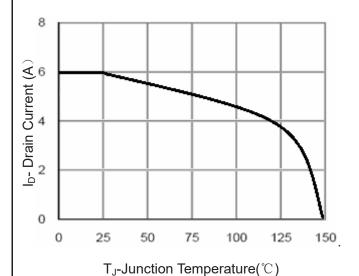


Figure 4 Drain Current

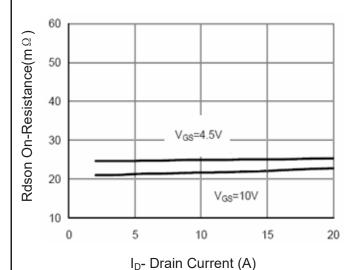


Figure 6 Drain-Source On-Resistance



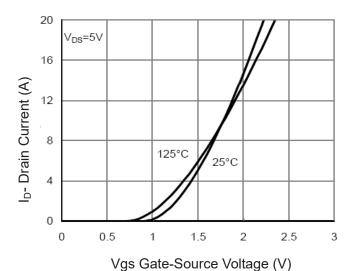
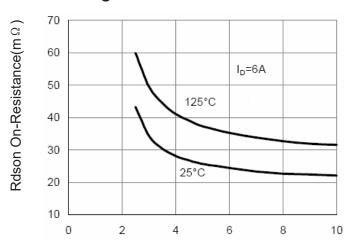


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

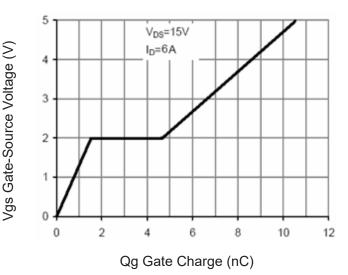


Figure 11 Gate Charge

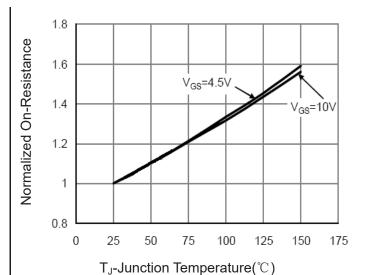


Figure 8 Drain-Source On-Resistance

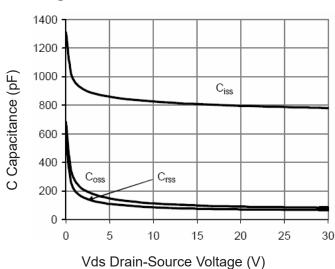


Figure 10 Capacitance vs Vds

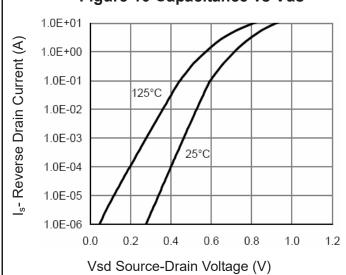


Figure 12 Source- Drain Diode Forward



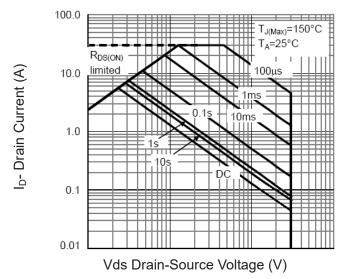


Figure 13 Safe Operation Area

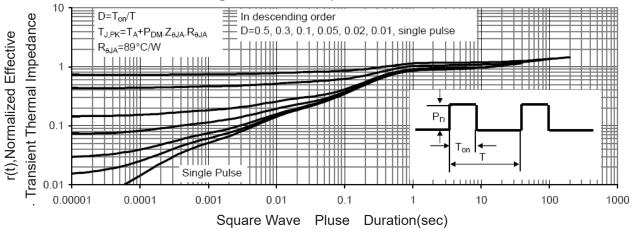
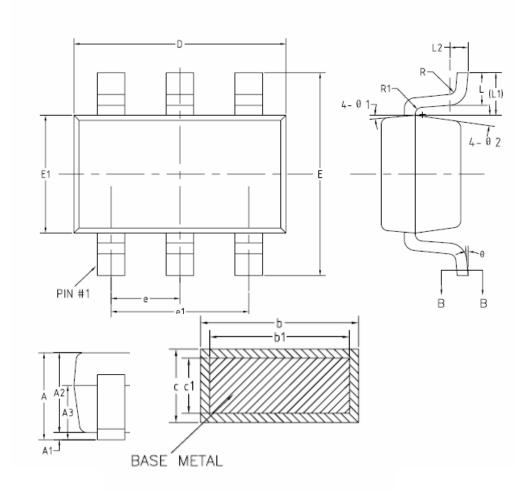


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT23-6L Package Information



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
A	_	-	1.45		
A1	0	_	0.15		
A2	0.90	1.10	1.30		
A3	0.60	0.65	0.70		
Ь	0.39	_	0.49		
b1	0.38	0.40	0.45		
С	0.12	-	0.19		
c1	0.11	0.13	0.15		
D	2.85	2.95	3.05		
E	2.60	2.80	3.00		
E1	1.55	1.65	1.75		
е	0.85	0.95	1.05		
e1	1.80	1.90	2.00		
L	0.35	0.45	0.60		
L1		0.59REF			
L2	0.25BSC				
R	0.05	-	_		
R1	0.05	-	0.20		
θ	0.	_	8*		
θ 1	8*	10°	12*		
θ 2	8°	10°	12°		